

POTTING COMPOUND, EPOXY
Bisphenol A-Type
Filled, Heat Cure, High HDT

1. SCOPE:

1.1 Form: This specification covers an epoxy resin formulation supplied as a two-component system, requiring an oven cure for attainment of maximum properties.

1.2 Application: Primarily for use as a potting or sealing material where a high heat deflection temperature (HDT) is desired.

2. APPLICABLE DOCUMENTS: See AMS 3731.

3. TECHNICAL REQUIREMENTS:

3.1 Basic Specification: The complete requirements for procuring the product described herein shall consist of this document and the latest issue of the basic specification, AMS 3731.

3.2 Material: Shall be an epoxy-based polymer with a filler and a curing agent.

3.3 Properties: The compound shall conform to the following requirements:

3.3.1 Mixed Uncured Compound: The compound, mixed in accordance with manufacturer's instructions, shall exhibit the following properties:

3.3.1.1 Viscosity: Shall be not greater than 5000 centipoise (5.0 Pa·s) at 23°C (73°F), determined within 5 min. after mixing, using a Brookfield Model LVF viscometer and No. 3 spindle at 6 revolutions per minute.

3.3.1.2 Pot Life: Usable life of the compound, defined as the time to attain double the initial viscosity determined in 3.3.1.1, shall be not less than 30 min. at 23°C (73°F).

REAFFIRMED

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3.3.1.3 Curing Time: The time required to develop the cured product properties specified in 3.3.2 shall be not more than 3 hr at 95°C (200°F) followed by not more than 16 hr at 205°C (400°F) or not more than 16 hr at 205°C (400°F).

3.3.2 Cured Product: The compound, mixed and cured in accordance with manufacturer's instructions, shall exhibit the following properties, determined in accordance with test methods listed in AMS 3731:

3.3.2.1	Flexural Strength, min	10,000 psi (70 MPa)
3.3.2.2	Izod Impact Strength, per unit of notch, min	0.28 ft-lb per in. (15 J/m)
3.3.2.3	Compressive Strength, min	15,000 psi (105 MPa)
3.3.2.4	Insulation Resistance	
3.3.2.4.1	At 23°C (73°F), min	1x10 ⁶ megohms
3.3.2.4.2	At 120°C (250°F), min	1x10 ⁶ megohms
3.3.2.4.3	After hydrolytic stability conditioning, min	1x10 ⁴ megohms
3.3.2.5	Dielectric Constant at 1 KHz, max	4.0
3.3.2.6	Dissipation Factor at 1 KHz, max	0.03
3.3.2.7	Heat Deflection Temperature at 264 psi (1.8 MPa), min	150°C (300°F)
3.3.2.8	Coefficient of Linear Thermal Expansion, max	
3.3.2.8.1	From -54°C to +23°C (-65°F to +73°F)	35x10 ⁻⁶ mm/mm per deg C (20x10 ⁻⁶ in./in. per deg F)
3.3.2.8.2	From 23°C to 74°C (73°F to 165°F)	45x10 ⁻⁶ mm/mm per deg C (25x10 ⁻⁶ in./in. per deg F)
3.3.2.9	Water Absorption after 24 hr Immersion, max	0.1%
3.3.2.10	Specific Gravity, max	2.2
3.3.2.11	Flammability (extent of burning), max	1 in. (25 mm)